

Special Issue

Lifelog and Information Retrieval from Daily Digital Data

Message from the Guest Editor

The main aim of this Special Issue is to present novel approaches and results focusing on all of the interdisciplinary research topics involved in lifelog applications—data acquisition, semantic integration, data processing and mining, data categorization and summarization, and information retrieval data privacy and security, just to name a few. Contributions that explore all of these topics are welcome. **Keywords**

- mobile/wearable sensors and devices
- remote health monitoring
- data integration
- joint knowledge extraction
- semantic interoperability
- signal processing
- image processing
- data mining
- image and information retrieval
- sentiment analysis
- machine learning
- data privacy
- security

Guest Editor

Prof. Dr. António J. R. Neves

Department of Electronics, Telecommunications and Informatics,
University of Aveiro, Aveiro, Portugal

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Applied Sciences
Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland
Tel: +41 61 683 77 34
appls@mdpi.com

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About the Journal

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo
Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32,
20133 Milano, Italy

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